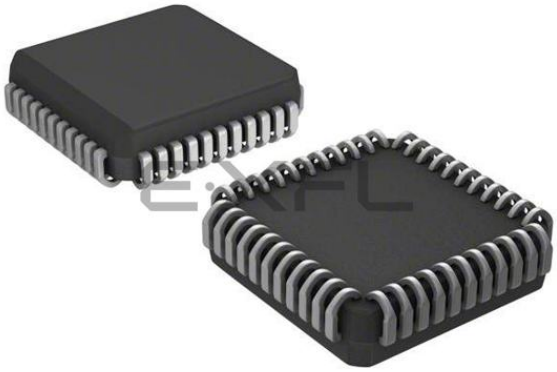

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	8KB (4K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c43-33-l

FIGURE 4-2: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ TIED TO V_{DD})

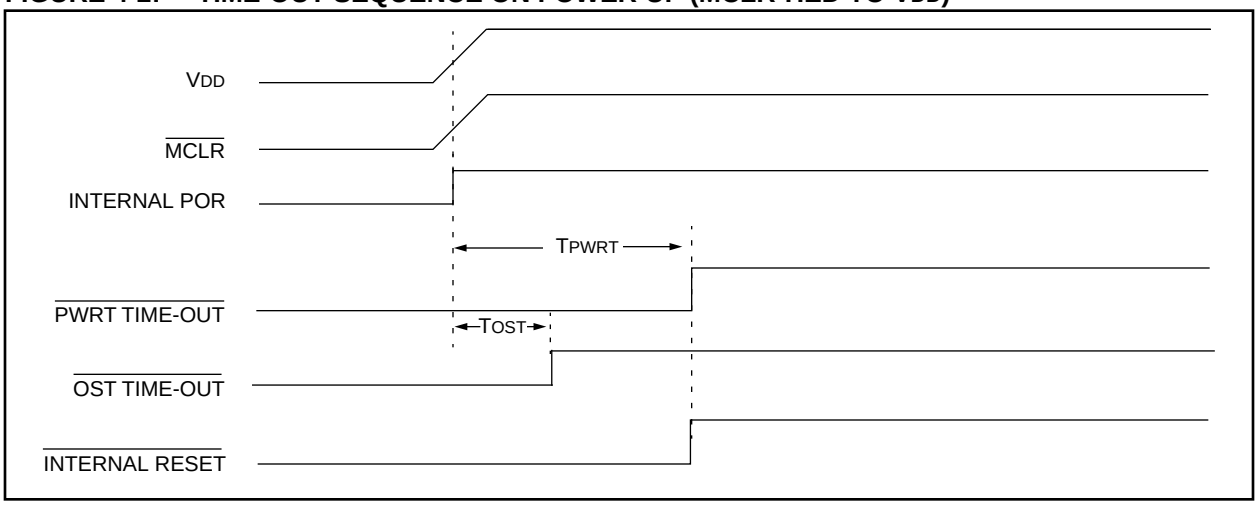


FIGURE 4-3: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ NOT TIED TO V_{DD})

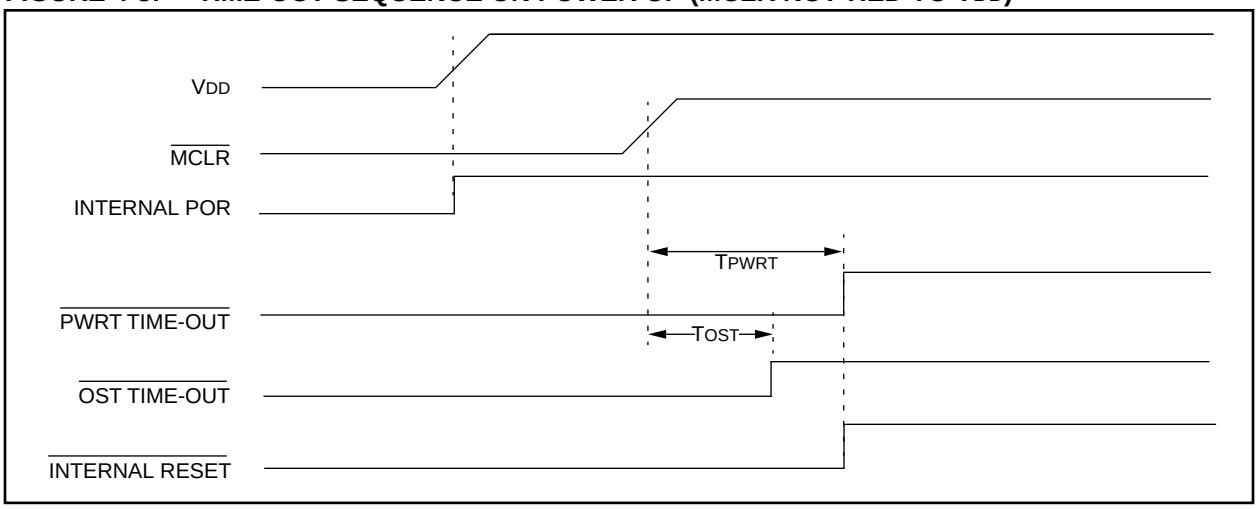


FIGURE 4-4: SLOW RISE TIME ($\overline{MCLR}$ TIED TO V_{DD})

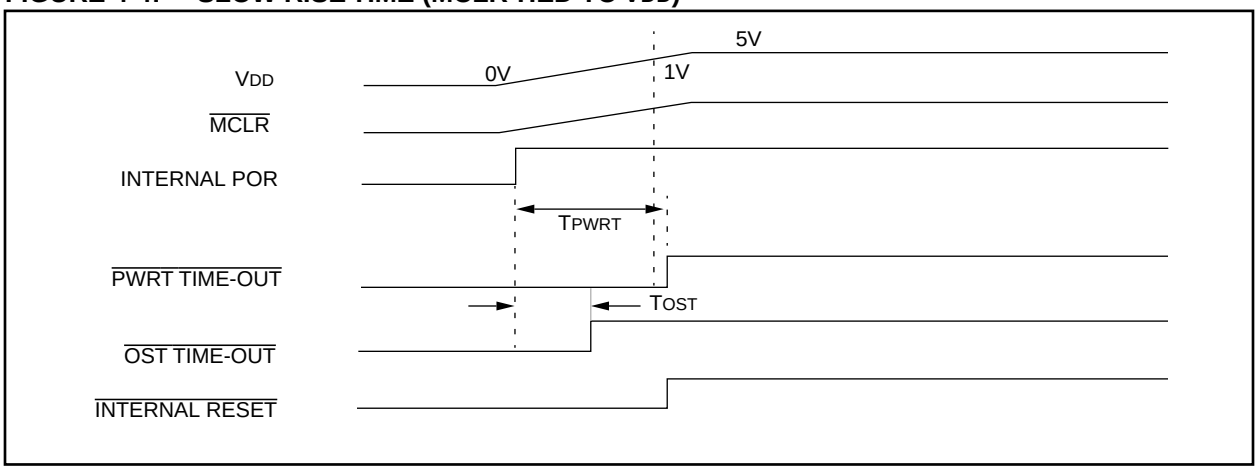
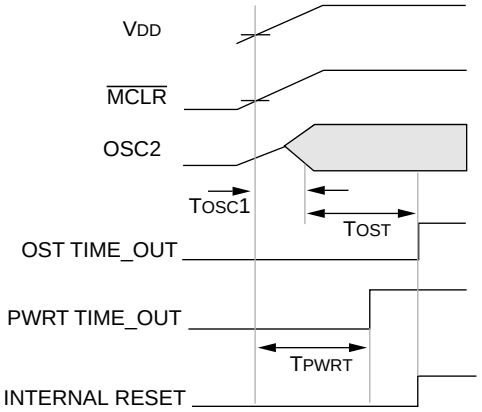


FIGURE 4-5: OSCILLATOR START-UPTIME



This figure shows in greater detail the timings involved with the oscillator start-up timer. In this example the low frequency crystal start-up time is larger than power-up time (TPWRT).
Tosc1 = time for the crystal oscillator to react to an oscillation level detectable by the Oscillator Start-up Timer (ost).
TOST = 1024TOSC.

FIGURE 4-6: USING ON-CHIP POR

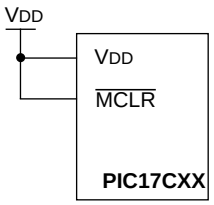
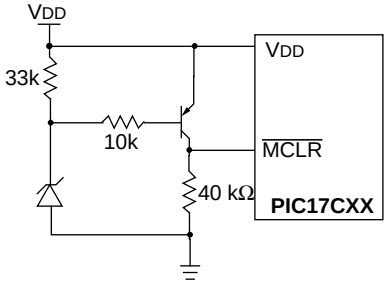
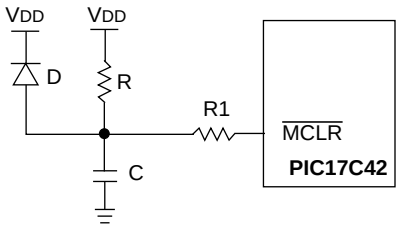


FIGURE 4-7: BROWN-OUT PROTECTION CIRCUIT 1



This circuit will activate reset when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.

FIGURE 4-8: PIC17C42 EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)

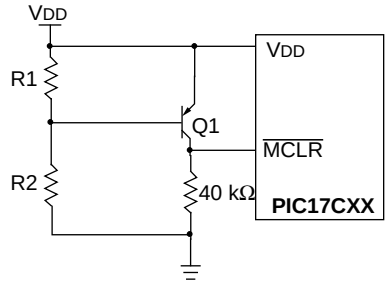


Note 1: An external Power-on Reset circuit is required only if VDD power-up time is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.

2: R < 40 kΩ is recommended to ensure that the voltage drop across R does not exceed 0.2V (max. leakage current spec. on the MCLR/VPP pin is 5 μA). A larger voltage drop will degrade VIH level on the MCLR/VPP pin.

3: R1 = 100Ω to 1 kΩ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or (Electrical Overstress) EOS.

FIGURE 4-9: BROWN-OUT PROTECTION CIRCUIT 2



This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

5.9 Context Saving During Interrupts

During an interrupt, only the returned PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt; e.g. WREG, ALUSTA and the BSR registers. This requires implementation in software.

Example 5-1 shows the saving and restoring of information for an interrupt service routine. The PUSH and POP routines could either be in each interrupt service routine or could be subroutines that were called. Depending on the application, other registers may also need to be saved, such as PCLATH.

EXAMPLE 5-1: SAVING STATUS AND WREG IN RAM

```
;
; The addresses that are used to store the CPUSTA and WREG values
; must be in the data memory address range of 18h - 1Fh. Up to
; 8 locations can be saved and restored using
; the MOVFP instruction. This instruction neither affects the status
; bits, nor corrupts the WREG register.
;
;
PUSH    MOVFP   WREG, TEMP_W         ; Save WREG
        MOVFP   ALUSTA, TEMP_STATUS  ; Save ALUSTA
        MOVFP   BSR, TEMP_BSR        ; Save BSR

ISR     :                            ; This is the interrupt service routine
        :
POP     MOVFP   TEMP_W, WREG         ; Restore WREG
        MOVFP   TEMP_STATUS, ALUSTA  ; Restore ALUSTA
        MOVFP   TEMP_BSR, BSR        ; Restore BSR
        RETFIE                       ; Return from Interrupts enabled
```

6.2.2.2 CPU STATUS REGISTER (CPUSTA)

The CPUSTA register contains the status and control bits for the CPU. This register is used to globally enable/disable interrupts. If only a specific interrupt is desired to be enabled/disabled, please refer to the INTerrupt STAtus (INTSTA) register and the Peripheral Interrupt Enable (PIE) register. This register also indicates if the stack is available and contains the Power-down ($\overline{PD}$) and Time-out ($\overline{TO}$) bits. The $\overline{TO}$, $\overline{PD}$, and STKAV bits are not writable. These bits are set and cleared according to device logic. Therefore, the result of an instruction with the CPUSTA register as destination may be different than intended.

FIGURE 6-8: CPUSTA REGISTER (ADDRESS: 06h, UNBANKED)

U - 0	U - 0	R - 1	R/W - 1	R - 1	R - 1	U - 0	U - 0
—	—	STKAV	GLINTD	$\overline{TO}$	$\overline{PD}$	—	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented bit, Read as '0'
- n = Value at POR reset

bit 7-6: **Unimplemented**: Read as '0'

bit 5: **STKAV**: Stack Available bit
This bit indicates that the 4-bit stack pointer value is Fh, or has rolled over from Fh→ 0h (stack overflow).
1 = Stack is available
0 = Stack is full, or a stack overflow may have occurred (Once this bit has been cleared by a stack overflow, only a device reset will set this bit)

bit 4: **GLINTD**: Global Interrupt Disable bit
This bit disables all interrupts. When enabling interrupts, only the sources with their enable bits set can cause an interrupt.
1 = Disable all interrupts
0 = Enables all un-masked interrupts

bit 3: **$\overline{TO}$**: WDT Time-out Status bit
1 = After power-up or by a CLRWDT instruction
0 = A Watchdog Timer time-out occurred

bit 2: **$\overline{PD}$**: Power-down Status bit
1 = After power-up or by the CLRWDT instruction
0 = By execution of the SLEEP instruction

bit 1-0: **Unimplemented**: Read as '0'

9.0 I/O PORTS

The PIC17C4X devices have five I/O ports, PORTA through PORTE. PORTB through PORTE have a corresponding Data Direction Register (DDR), which is used to configure the port pins as inputs or outputs. These five ports are made up of 33 I/O pins. Some of these ports pins are multiplexed with alternate functions.

PORTC, PORTD, and PORTE are multiplexed with the system bus. These pins are configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, these pins are general purpose I/O.

PORTA and PORTB are multiplexed with the peripheral features of the device. These peripheral features are:

- Timer modules
- Capture module
- PWM module
- USART/SCI module
- External Interrupt pin

When some of these peripheral modules are turned on, the port pin will automatically configure to the alternate function. The modules that do this are:

- PWM module
- USART/SCI module

When a pin is automatically configured as an output by a peripheral module, the pins data direction (DDR) bit is unknown. After disabling the peripheral module, the user should re-initialize the DDR bit to the desired configuration.

The other peripheral modules (which require an input) must have their data direction bit configured appropriately.

Note:	A pin that is a peripheral input, can be configured as an output (DDRx<y> is cleared). The peripheral events will be determined by the action output on the port pin.

9.1 PORTA Register

PORTA is a 6-bit wide latch. PORTA does not have a corresponding Data Direction Register (DDR).

Reading PORTA reads the status of the pins.

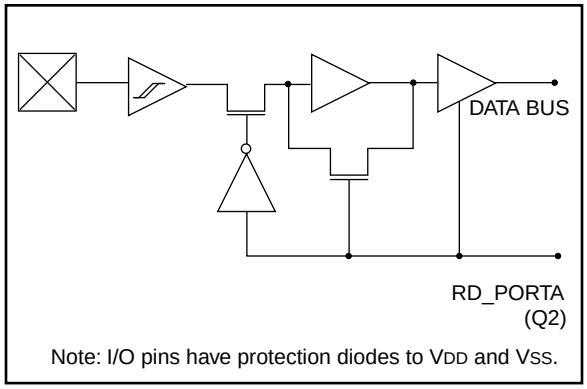
The RA1 pin is multiplexed with TMR0 clock input, and RA4 and RA5 are multiplexed with the USART functions. The control of RA4 and RA5 as outputs is automatically configured by the USART module.

9.1.1 USING RA2, RA3 AS OUTPUTS

The RA2 and RA3 pins are open drain outputs. To use the RA2 or the RA3 pin(s) as output(s), simply write to the PORTA register the desired value. A '0' will cause the pin to drive low, while a '1' will cause the pin to float (hi-impedance). An external pull-up resistor should be used to pull the pin high. Writes to PORTA will not affect the other pins.

Note:	When using the RA2 or RA3 pin(s) as output(s), read-modify-write instructions (such as BCF, BSF, BTG) on PORTA are not recommended. Such operations read the port pins, do the desired operation, and then write this value to the data latch. This may inadvertently cause the RA2 or RA3 pins to switch from input to output (or vice-versa). It is recommended to use a shadow register for PORTA. Do the bit operations on this shadow register and then move it to PORTA.

FIGURE 9-1: RA0 AND RA1 BLOCK DIAGRAM



Note: I/O pins have protection diodes to VDD and VSS.

9.5 I/O Programming Considerations

9.5.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. For example, the BCF and BSF instructions read the register into the CPU, execute the bit operation, and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (e.g. bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Reading a port reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (BCF, BSF, BTG, etc.) on a port, the value of the port pins is read, the desired operation is performed with this value, and the value is then written to the port latch.

Example 9-5 shows the effect of two sequential read-modify-write instructions on an I/O port.

EXAMPLE 9-5: READ MODIFY WRITE INSTRUCTIONS ON AN I/O PORT

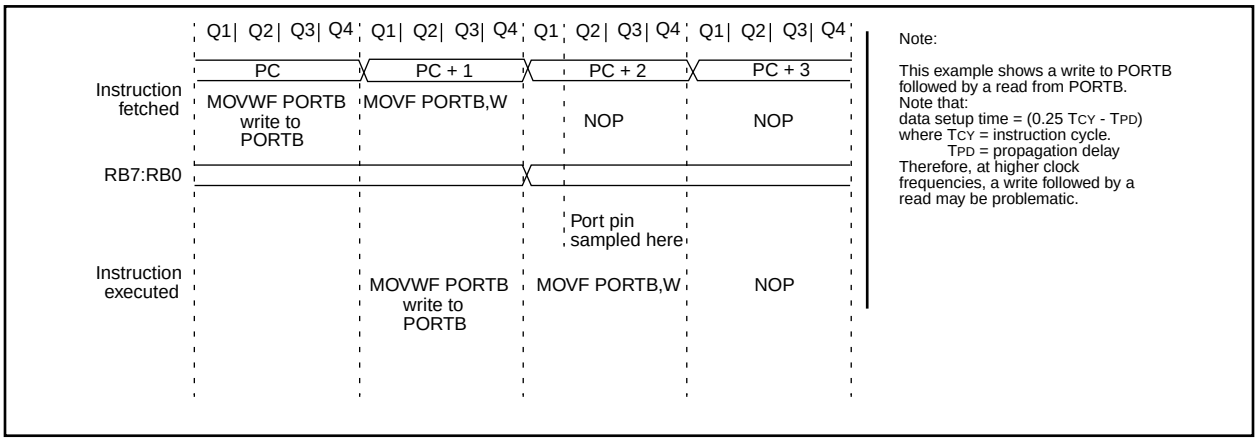
```
; Initial PORT settings: PORTB<7:4> Inputs
;                        PORTB<3:0> Outputs
; PORTB<7:6> have pull-ups and are
; not connected to other circuitry
;
;                       PORT latch  PORT pins
;                       ----------  ---------
;
   BCF   PORTB, 7       01pp pppp   11pp pppp
   BCF   PORTB, 6       10pp pppp   11pp pppp
;
   BCF   DDRB, 7        10pp pppp   11pp pppp
   BCF   DDRB, 6        10pp pppp   10pp pppp
;
; Note that the user may have expected the
; pin values to be 00pp pppp. The 2nd BCF
; caused RB7 to be latched as the pin value
; (High).
```

Note:	A pin actively outputting a Low or High should not be driven from external devices in order to change the level on this pin (i.e. “wired-or”, “wired-and”). The resulting high output currents may damage the device.

9.5.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 9-9). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before executing the instruction that reads the values on that I/O port. Otherwise, the previous state of that pin may be read into the CPU rather than the “new” state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

FIGURE 9-9: SUCCESSIVE I/O OPERATION



11.0 TIMER0

The Timer0 module consists of a 16-bit timer/counter, TMR0. The high byte is TMR0H and the low byte is TMR0L. A software programmable 8-bit prescaler makes an effective 24-bit overflow timer. The clock source is also software programmable as either the internal instruction clock or the RA1/T0CKI pin. The control bits for this module are in register T0STA (Figure 11-1).

FIGURE 11-1: T0STA REGISTER (ADDRESS: 05h, UNBANKED)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0
INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented, Read as '0'
-n = Value at POR reset

bit 7: **INTEDG**: RA0/INT Pin Interrupt Edge Select bit
This bit selects the edge upon which the interrupt is detected
1 = Rising edge of RA0/INT pin generates interrupt
0 = Falling edge of RA0/INT pin generates interrupt

bit 6: **T0SE**: Timer0 Clock Input Edge Select bit
This bit selects the edge upon which TMR0 will increment
When T0CS = 0
1 = Rising edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
0 = Falling edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
When T0CS = 1
Don't care

bit 5: **T0CS**: Timer0 Clock Source Select bit
This bit selects the clock source for TMR0.
1 = Internal instruction clock cycle (T_{CY})
0 = T0CKI pin

bit 4-1: **PS3:PS0**: Timer0 Prescale Selection bits
These bits select the prescale value for TMR0.

PS3:PS0	Prescale Value
0000	1:1
0001	1:2
0010	1:4
0011	1:8
0100	1:16
0101	1:32
0110	1:64
0111	1:128
1xxx	1:256

bit 0: **Unimplemented**: Read as '0'

12.2.3 EXTERNAL CLOCK INPUT FOR TIMER3

When TMR3CS is set, the 16-bit TMR3 increments on the falling edge of clock input TCLK3. The input on the RB5/TCLK3 pin is sampled and synchronized by the internal phase clocks twice every instruction cycle. This causes a delay from the time a falling edge appears on TCLK3 to the time TMR3 is actually incremented. For the external clock input timing requirements, see the Electrical Specification section. Figure 12-9 shows the timing diagram when operating from an external clock.

12.2.4 READING/WRITING TIMER3

Since Timer3 is a 16-bit timer and only 8-bits at a time can be read or written, care should be taken when reading or writing while the timer is running. The best method to read or write the timer is to stop the timer, perform any read or write operation, and then restart Timer3 (using the TMR3ON bit). However, if it is necessary to keep Timer3 free-running, care must be taken. For writing to the 16-bit TMR3, Example 12-2 may be used. For reading the 16-bit TMR3, Example 12-3 may be used. Interrupts must be disabled during this routine.

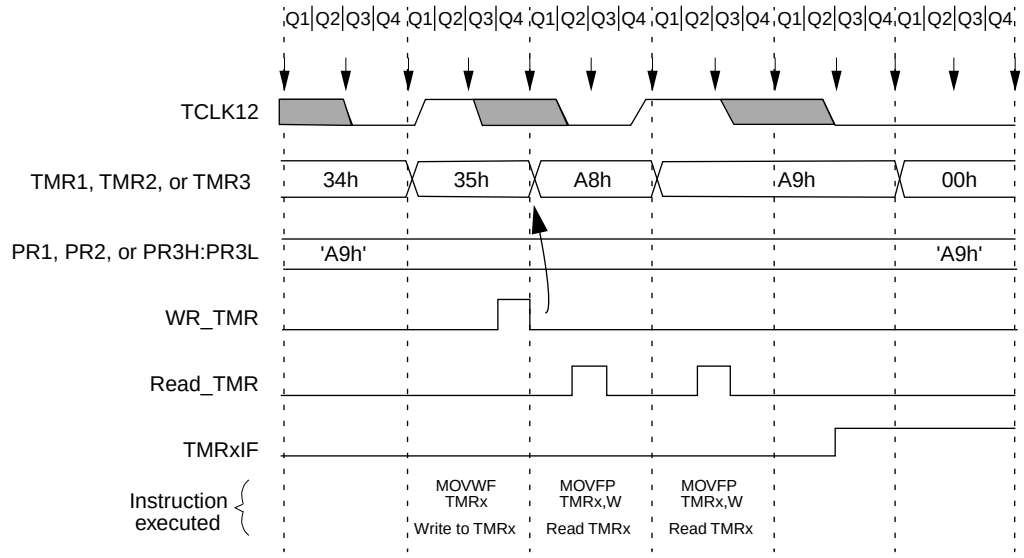
EXAMPLE 12-2: WRITING TO TMR3

```
BSF   CPUSTA, GLINTD ;Disable interrupt
MOVFP RAM_L,  TMR3L  ;
MOVFP RAM_H,  TMR3H  ;
BCF   CPUSTA, GLINTD ;Done,enable interrupt
```

EXAMPLE 12-3: READING FROM TMR3

```
MOVPF   TMR3L, TMPLO    ;read low tmr0
MOVPF   TMR3H, TMPHI    ;read high tmr0
MOVFP   TMPLO, WREG     ;tmplo -> wreg
CPFSLT  TMR3L, WREG     ;tmr0l < wreg?
RETURN                  ;no then return
MOVPF   TMR3L, TMPLO    ;read low tmr0
MOVPF   TMR3H, TMPHI    ;read high tmr0
RETURN                  ;return
```

FIGURE 12-9: TMR1, TMR2, AND TMR3 OPERATION IN EXTERNAL CLOCK MODE



Note 1: TCLK12 is sampled in Q2 and Q4.
2: ↓ indicates a sampling point.
3: The latency from TCLK12 ↓ to timer increment is between 2Tosc and 6Tosc.

TABLE 13-3: BAUD RATES FOR SYNCHRONOUS MODE

BAUD RATE (K)	FOSC = 33 MHz			FOSC = 25 MHz			FOSC = 20 MHz			FOSC = 16 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	NA	—	—	NA	—	—
2.4	NA	—	—	NA	—	—	NA	—	—	NA	—	—
9.6	NA	—	—	NA	—	—	NA	—	—	NA	—	—
19.2	NA	—	—	NA	—	—	19.53	+1.73	255	19.23	+0.16	207
76.8	77.10	+0.39	106	77.16	+0.47	80	76.92	+0.16	64	76.92	+0.16	51
96	95.93	-0.07	85	96.15	+0.16	64	96.15	+0.16	51	95.24	-0.79	41
300	294.64	-1.79	27	297.62	-0.79	20	294.1	-1.96	16	307.69	+2.56	12
500	485.29	-2.94	16	480.77	-3.85	12	500	0	9	500	0	7
HIGH	8250	—	0	6250	—	0	5000	—	0	4000	—	0
LOW	32.22	—	255	24.41	—	255	19.53	—	255	15.625	—	255

BAUD RATE (K)	FOSC = 10 MHz			FOSC = 7.159 MHz			FOSC = 5.068 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	NA	—	—
2.4	NA	—	—	NA	—	—	NA	—	—
9.6	9.766	+1.73	255	9.622	+0.23	185	9.6	0	131
19.2	19.23	+0.16	129	19.24	+0.23	92	19.2	0	65
76.8	75.76	-1.36	32	77.82	+1.32	22	79.2	+3.13	15
96	96.15	+0.16	25	94.20	-1.88	18	97.48	+1.54	12
300	312.5	+4.17	7	298.3	-0.57	5	316.8	+5.60	3
500	500	0	4	NA	—	—	NA	—	—
HIGH	2500	—	0	1789.8	—	0	1267	—	0
LOW	9.766	—	255	6.991	—	255	4.950	—	255

BAUD RATE (K)	FOSC = 3.579 MHz			FOSC = 1 MHz			FOSC = 32.768 kHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	0.303	+1.14	26
1.2	NA	—	—	1.202	+0.16	207	1.170	-2.48	6
2.4	NA	—	—	2.404	+0.16	103	NA	—	—
9.6	9.622	+0.23	92	9.615	+0.16	25	NA	—	—
19.2	19.04	-0.83	46	19.24	+0.16	12	NA	—	—
76.8	74.57	-2.90	11	83.34	+8.51	2	NA	—	—
96	99.43	_3.57	8	NA	—	—	NA	—	—
300	298.3	-0.57	2	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	894.9	—	0	250	—	0	8.192	—	0
LOW	3.496	—	255	0.976	—	255	0.032	—	255

TABLE 13-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h, Bank 0	RCREG	RX7	RX6	RX5	RX4	RX3	RX2	RX1	RX0	xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
17h, Bank 0	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for synchronous master reception.

Note 1: Other (non power-up) resets include: external reset through $\overline{\text{MCLR}}$ and Watchdog Timer Reset.

14.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real time applications. The PIC17CXX family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- OSC selection
- Reset
  - Power-on Reset (POR)
  - Power-up Timer (PWRT)
  - Oscillator Start-up Timer (OST)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code protection

The PIC17CXX has a Watchdog Timer which can be shut off only through EPROM bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 96 ms (nominal) on power-up only, designed to keep the part in RESET while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

The SLEEP mode is designed to offer a very low current power-down mode. The user can wake from SLEEP through external reset, Watchdog Timer Reset or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LF crystal option saves power. Configuration bits are used to select various options. This configuration word has the format shown in Figure 14-1.

FIGURE 14-1: CONFIGURATION WORD

R/P - 1	U - x	U - x	U - x	U - x	U - x	U - x	U - x
PM2 (1)	—	—	—	—	—	—	—
bit15-7							bit0

U - x	R/P - 1	U - x	R/P - 1	R/P - 1	R/P - 1	R/P - 1	R/P - 1
—	PM1	—	PM0	WDTPS1	WDTPS0	FOSC1	FOSC0
bit15-7							bit0

R = Readable bit
P = Programmable bit
U = Unimplemented
- n = Value for Erased Device
(x = unknown)

bit 15-9: **Unimplemented**: Read as a '1'

bit 15,6,4:**PM2, PM1, PM0**, Processor Mode Select bits
111 = Microprocessor Mode
110 = Microcontroller mode
101 = Extended microcontroller mode
000 = Code protected microcontroller mode

bit 7, 5: **Unimplemented**: Read as a '0'

bit 3-2: **WDTPS1:WDTPS0**, WDT Postscaler Select bits
11 = WDT enabled, postscaler = 1
10 = WDT enabled, postscaler = 256
01 = WDT enabled, postscaler = 64
00 = WDT disabled, 16-bit overflow timer

bit 1-0: **FOSC1:FOSC0**, Oscillator Select bits
11 = EC oscillator
10 = XT oscillator
01 = RC oscillator
00 = LF oscillator

Note 1: This bit does not exist on the PIC17C42. Reading this bit will return an unknown value (x).

14.2.4 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used: one with series resonance, or one with parallel resonance.

Figure 14-5 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 kΩ resistor provides the negative feedback for stability. The 10 kΩ potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 14-5: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

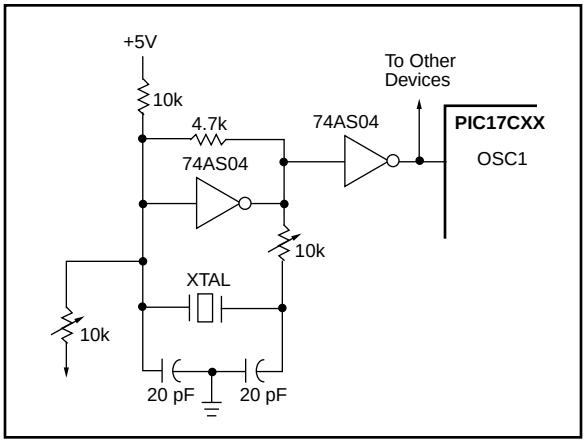
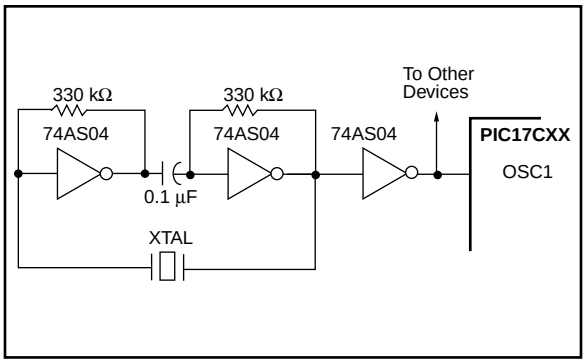


Figure 14-6 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 kΩ resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 14-6: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



14.2.5 RC OSCILLATOR

For timing insensitive applications, the RC device option offers additional cost savings. RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 14-6 shows how the R/C combination is connected to the PIC17CXX. For Rext values below 2.2 kΩ, the oscillator operation may become unstable, or stop completely. For very high Rext values (e.g. 1 MΩ), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep Rext between 3 kΩ and 100 kΩ.

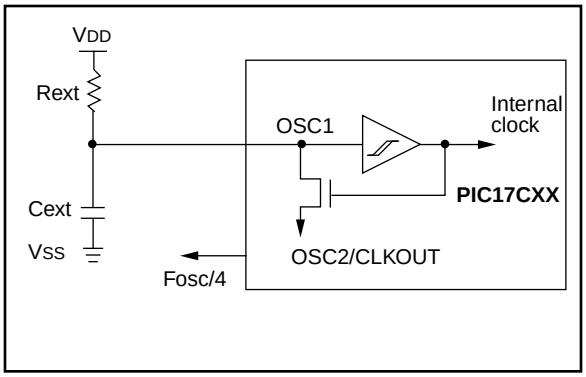
Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With little or no external capacitance, oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See Section 18.0 for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See Section 18.0 for variation of oscillator frequency due to VDD for given Rext/Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-2 for waveform).

FIGURE 14-7: RC OSCILLATOR MODE



15.2 Q Cycle Activity

Each instruction cycle (Tcy) is comprised of four Q cycles (Q1-Q4). The Q cycles provide the timing/designation for the Decode, Read, Execute, Write etc., of each instruction cycle. The following diagram shows the relationship of the Q cycles to the instruction cycle.

The 4 Q cycles that make up an instruction cycle (Tcy) can be generalized as:

Q1: Instruction Decode Cycle or forced NOP

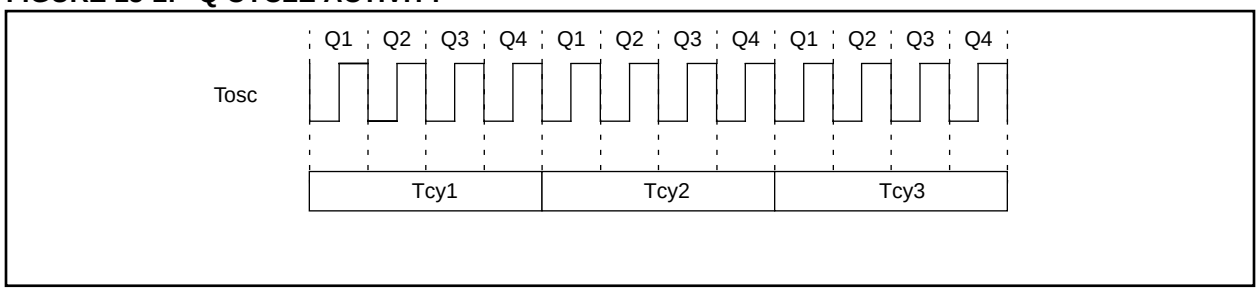
Q2: Instruction Read Cycle or NOP

Q3: Instruction Execute

Q4: Instruction Write Cycle or NOP

Each instruction will show the detailed Q cycle operation for the instruction.

FIGURE 15-2: Q CYCLE ACTIVITY



DECF **Decrement f**

Syntax: [*label*] DECF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (f) – 1 → (dest)

Status Affected: OV, C, DC, Z

Encoding:

0000	011d	ffff	ffff

Description: Decrement register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example:
```
DECF    CNT,   1
```
Before Instruction
CNT = 0x01
Z = 0

After Instruction
CNT = 0x00
Z = 1

DECFSZ **Decrement f, skip if 0**

Syntax: [*label*] DECFSZ f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (f) – 1 → (dest);
skip if result = 0

Status Affected: None

Encoding:

0001	011d	ffff	ffff

Description: The contents of register 'f' are decremented. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.
If the result is 0, the next instruction, which is already fetched, is discarded, and an NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example:
```
HERE    DECFSZ  CNT, 1
        GOTO    LOOP
CONTINUE
```
Before Instruction
PC = Address (HERE)

After Instruction
CNT = CNT - 1
If CNT = 0;
PC = Address (CONTINUE)
If CNT ≠ 0;
PC = Address (HERE+1)

DCFSNZ **Decrement f, skip if not 0**

Syntax: [*label*] DCFSNZ f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (f) – 1 → (dest);
skip if not 0

Status Affected: None

Encoding:

0010	011d	ffff	ffff

Description: The contents of register 'f' are decremented. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.
If the result is not 0, the next instruction, which is already fetched, is discarded, and an NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

If skip:

Q1	Q2	Q3	Q4
Forced NOP	NOP	Execute	NOP

Example:
```
HERE    DCFSNZ  TEMP, 1
ZERO    :
NZERO   :
```

Before Instruction
TEMP_VALUE = ?

After Instruction
TEMP_VALUE = TEMP_VALUE - 1,
If TEMP_VALUE = 0;
PC = Address (ZERO)
If TEMP_VALUE ≠ 0;
PC = Address (NZERO)

GOTO **Unconditional Branch**

Syntax: [*label*] GOTO k

Operands: $0 \le k \le 8191$

Operation: k → PC<12:0>;
k<12:8> → PCLATH<4:0>,
PC<15:13> → PCLATH<7:5>

Status Affected: None

Encoding:

110k	kkkk	kkkk	kkkk

Description: GOTO allows an unconditional branch anywhere within an 8K page boundary. The thirteen bit immediate value is loaded into PC bits <12:0>. Then the upper eight bits of PC are loaded into PCLATH. GOTO is always a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>	Execute	NOP
Forced NOP	NOP	Execute	NOP

Example:
```
GOTO THERE
```

After Instruction
PC = Address (THERE)

NEGW **Negate W**

Syntax: [*label*] NEGW f,s

Operands: $0 \le F \le 255$
$s \in [0,1]$

Operation: $\overline{WREG} + 1 \rightarrow (f)$;
$\overline{WREG} + 1 \rightarrow s$

Status Affected: OV, C, DC, Z

Encoding:

0010	110s	ffff	ffff

Description: WREG is negated using two's complement. If 's' is 0 the result is placed in WREG and data memory location 'f'. If 's' is 1 the result is placed only in data memory location 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f' and other specified register

Example: `NEGW REG,0`

Before Instruction
WREG = 0011 1010 [0x3A],
REG = 1010 1011 [0xAB]

After Instruction
WREG = 1100 0111 [0xC6]
REG = 1100 0111 [0xC6]

NOP **No Operation**

Syntax: [*label*] NOP

Operands: None

Operation: No operation

Status Affected: None

Encoding:

0000	0000	0000	0000

Description: No operation.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	NOP	Execute	NOP

Example:

None.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 17-12: MEMORY INTERFACE READ TIMING

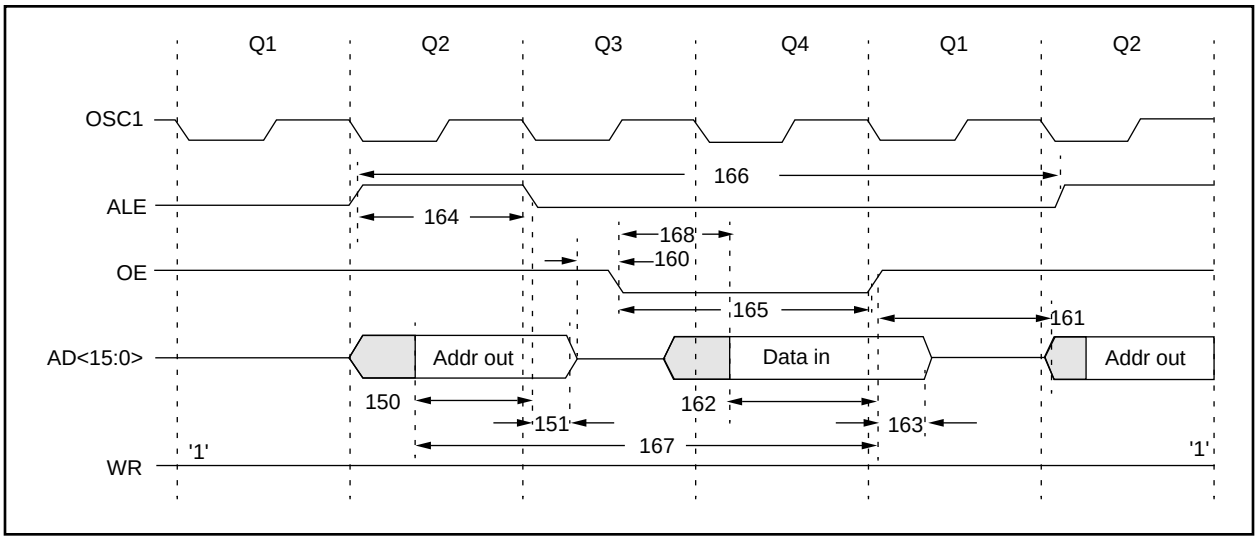


TABLE 17-12: MEMORY INTERFACE READ REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2alL	AD<15:0> (address) valid to ALE↓ (address setup time)	0.25Tcy - 30	—	—	ns	
151	TalL2adI	ALE↓ to address out invalid (address hold time)	5*	—	—	ns	
160	TadZ2oeL	AD<15:0> high impedance to $\overline{OE}$↓	0*	—	—	ns	
161	ToeH2adD	$\overline{OE}$↑ to AD<15:0> driven	0.25Tcy - 15	—	—	ns	
162	TadV2oeH	Data in valid before $\overline{OE}$↑ (data setup time)	35	—	—	ns	
163	ToeH2adI	$\overline{OE}$↑to data in invalid (data hold time)	0	—	—	ns	
164	TalH	ALE pulse width	—	0.25TCY §	—	ns	
165	ToeL	$\overline{OE}$ pulse width	0.5Tcy - 35 §	—	—	ns	
166	TalH2alH	ALE↑ to ALE↑ (cycle time)	—	TCY §	—	ns	
167	Tacc	Address access time	—	—	0.75 TCY-40	ns	
168	Toe	Output enable access time ($\overline{OE}$ low to Data Valid)	—	—	0.5 TCY - 60	ns	

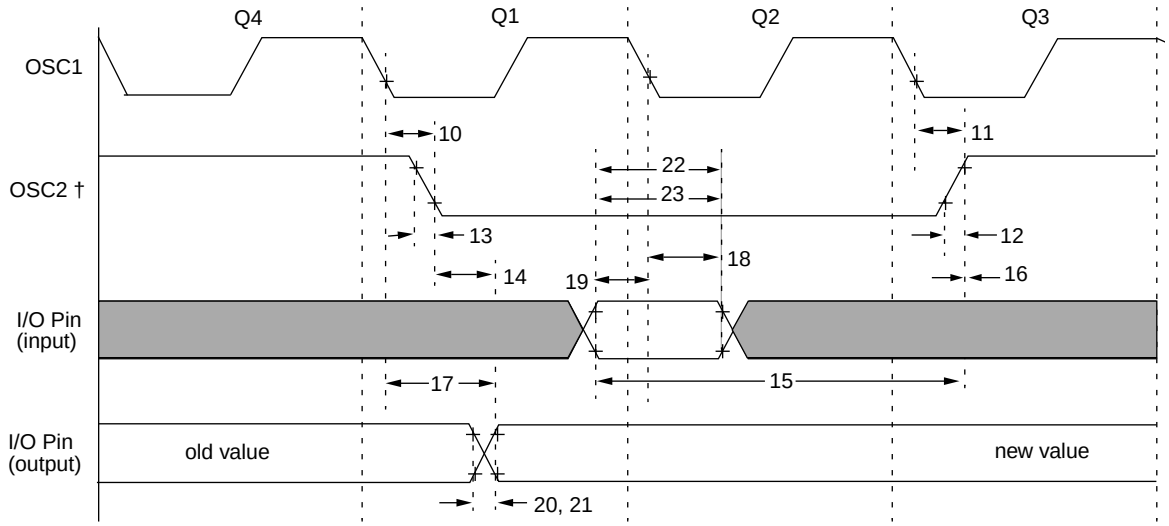
* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification guaranteed by design.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 19-3: CLKOUT AND I/O TIMING



† In EC and RC modes only.

TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10	TosH2ckL	OSC1↓ to CLKOUT↓		—	15 ‡	30 ‡	ns	Note 1
11	TosH2ckH	OSC1↓ to CLKOUT↑		—	15 ‡	30 ‡	ns	Note 1
12	TckR	CLKOUT rise time		—	5 ‡	15 ‡	ns	Note 1
13	TckF	CLKOUT fall time		—	5 ‡	15 ‡	ns	Note 1
14	TckH2ioV	CLKOUT ↑ to Port out valid	PIC17CR42/42A/43/ R43/44	—	—	0.5TCY + 20 ‡	ns	Note 1
			PIC17LCR42/42A/43/ R43/44	—	—	0.5TCY + 50 ‡	ns	Note 1
15	TioV2ckH	Port in valid before CLKOUT↑	PIC17CR42/42A/43/ R43/44	0.25TCY + 25 ‡	—	—	ns	Note 1
			PIC17LCR42/42A/43/ R43/44	0.25TCY + 50 ‡	—	—	ns	Note 1
16	TckH2ioI	Port in hold after CLKOUT↑		0 ‡	—	—	ns	Note 1
17	TosH2ioV	OSC1↓ (Q1 cycle) to Port out valid		—	—	100 ‡	ns	
18	TosH2ioI	OSC1↓ (Q2 cycle) to Port input invalid (I/O in hold time)		0 ‡	—	—	ns	
19	TioV2osH	Port input valid to OSC1↓ (I/O in setup time)		30 ‡	—	—	ns	
20	TioR	Port output rise time		—	10 ‡	35 ‡	ns	
21	TioF	Port output fall time		—	10 ‡	35 ‡	ns	
22	TinHL	INT pin high or low time		25 *	—	—	ns	
23	TrbHL	RB7:RB0 change INT high or low time		25 *	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Measurements are taken in EC Mode where CLKOUT output is 4 x TOSC.

Applicable Devices	42	R42	42A	43	R43	44

FIGURE 20-19: V_{TH}, V_{IL} of I/O PINS (SCHMITT TRIGGER) vs. V_{DD}

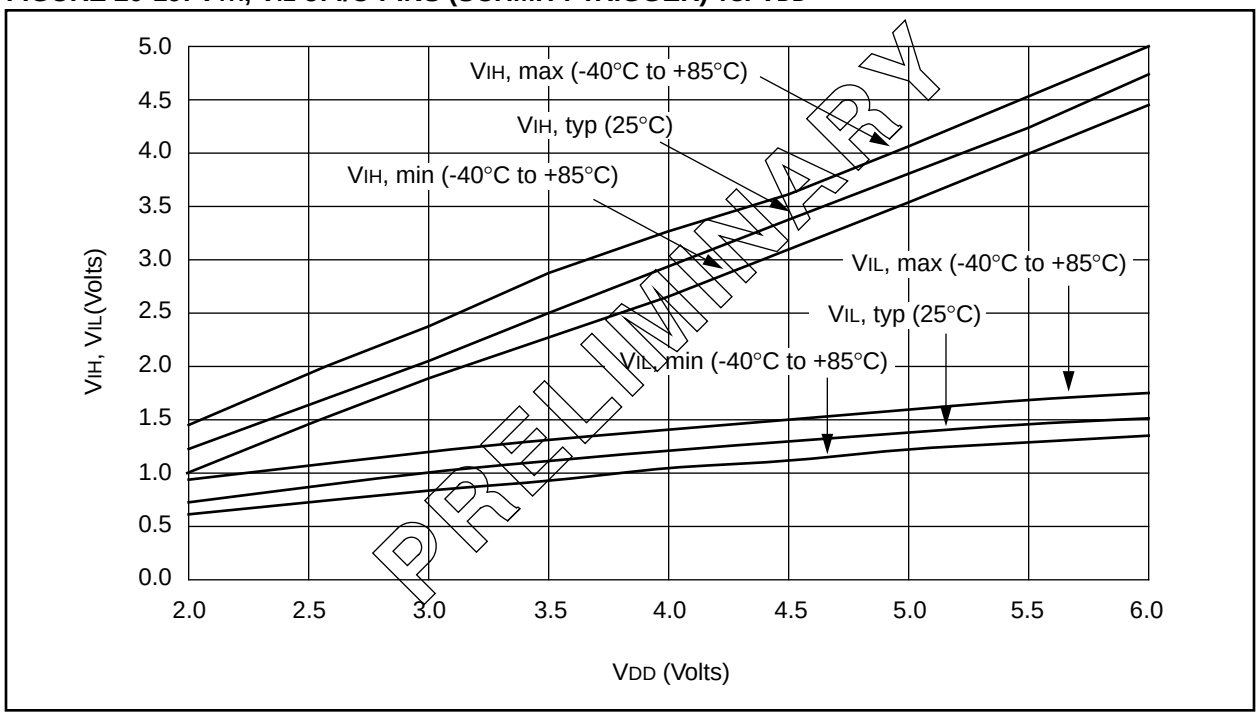
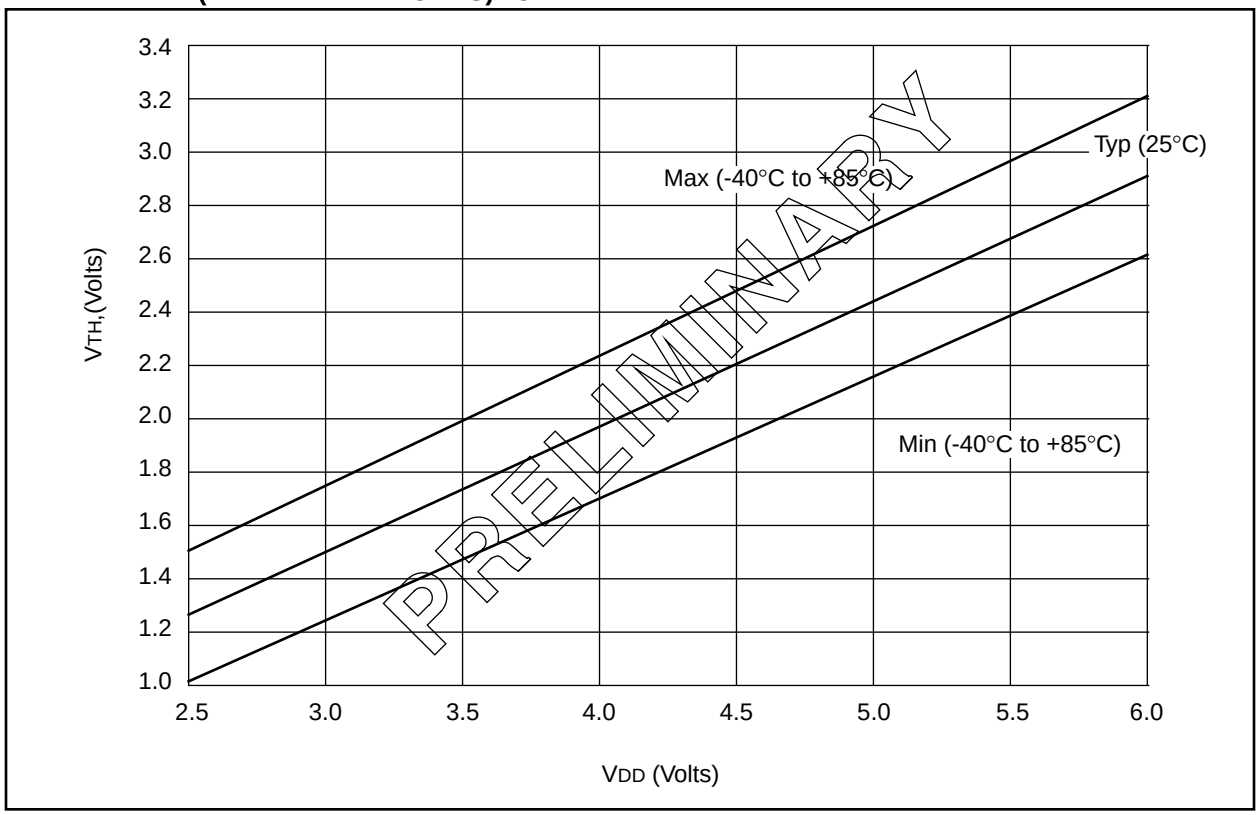


FIGURE 20-20: V_{TH} (INPUT THRESHOLD VOLTAGE) OF OSC1 INPUT (IN XT AND LF MODES) vs. V_{DD}



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